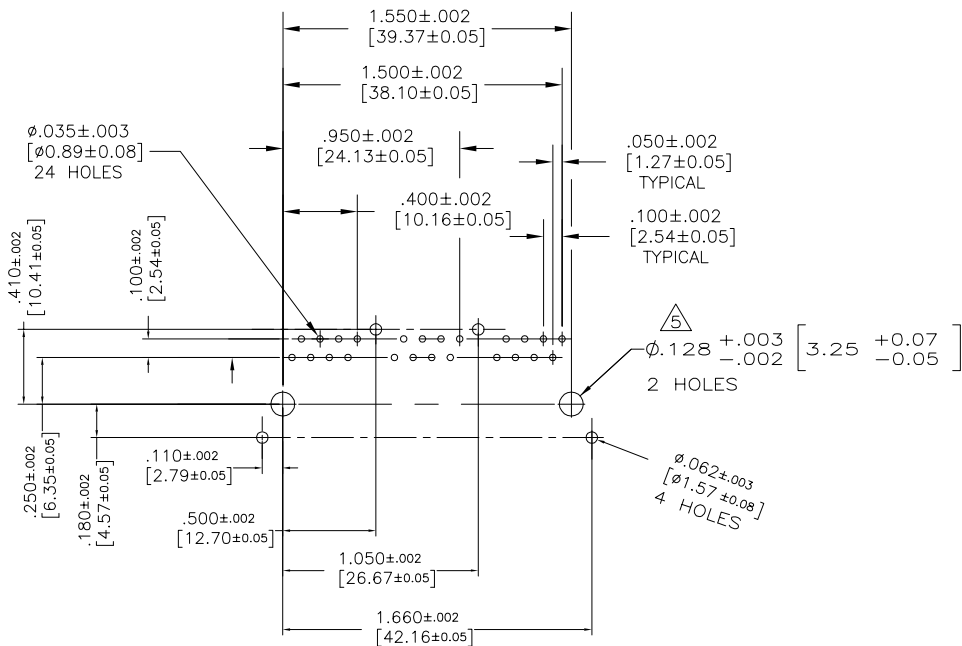
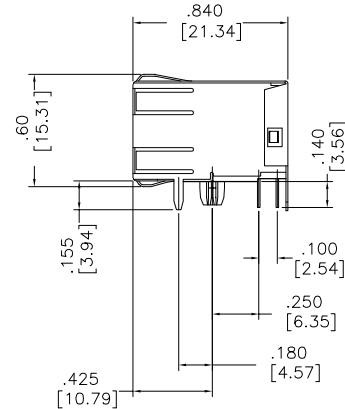
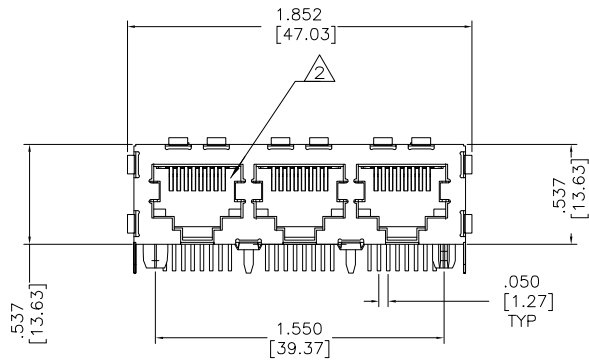


LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
AA	00		B1	ECR-09-004284	16APR2009	TY	SY

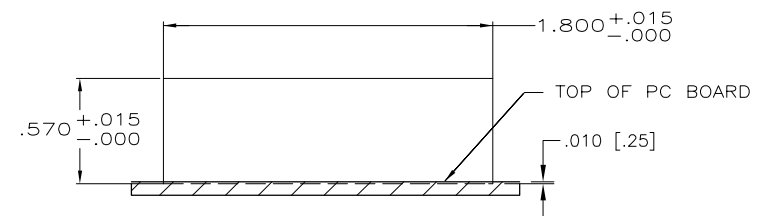


SUGGESTED PC BOARD LAYOUT
COMPONENT SIDE
SEE APPLICATION SPECIFICATION

- MATERIAL: HOUSING - HTN NYLON, BLACK, IR REFLOW PROCESSING COMPATIBLE, UL 94V-0. TERMINALS - .013[0.33] THICK PHOS BRONZE PLATED WITH .000050[1.27μm] THICK HARD GOLD IN LOCALIZED AREA AND .000150[3.81μm] THICK MATTE TIN IN SOLDER AREA OVER .000050[1.27μm] THICK NICKEL UNDERPLATE.

SHIELD - 0.010[.254m] THK. COPPER ALLOY PLATED WITH .000050[1.27μm] MIN. NICKEL AND .000080[2.03μm] MIN. HOT TIN DIP ON PCB GROUND TABS.

- JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.
- ALL DIMENSIONS SHOWN ARE NOMINAL UNLESS OTHERWISE SPECIFIED.
- ALL DIMENSIONS SHOWN IN BRACKETS [] ARE IN MILLIMETERS.
- USE #30 DRILL BIT OR 3.25 MM DRILL BIT WHEN PRODUCING THESE PRINTED CIRCUIT BOARD HOLES.



SUGGESTED PANEL CUTOUT

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN V. SLACK 1-28-92	Tyco Electronics Corporation Harrisburg, Pa 17105-3608			
DIMENSIONS: INCHES		CHK B. FOX 6-08-92	NAME			
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD G. REED 6-08-92	MODULAR JACK ASSEMBLY, THREE PORT, 8 POSITION, RIGHT ANGLE			
0 PLC ± - 1 PLC ± - 2 PLC ± .01[0.25] 3 PLC ± .005[0.13] 4 PLC ± - ANGLES ± -		PRODUCT SPEC 108-1163 APPLICATION SPEC 114-2048	SIZE A2			
MATERIAL SEE NOTE 1		WEIGHT -	CAGE CODE 00779			
FINISH SEE NOTE 1		CUSTOMER DRAWING	DRAWING NO 1761825			
		SCALE 2:1	SHEET 1 OF 1			
			REV B1			